APA600-FGG676 Information
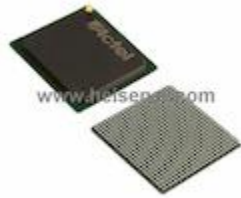
For Reference Only

Part Number	APA600-FGG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Description	IC FPGA 454 I/O 676FBGA
Package	676-BGA

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

APA600-FGG676 Specifications

Manufacturer Part Number	APA600-FGG676
Manufacturer	Microsemi Corporation
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	676-BGA
Series	ProASICPLUS
Number of LABs/CLBs	-
Number of Logic Elements/Cells	-
Total RAM Bits	129024
Number of I/O	454
Number of Gates	600000
Voltage - Supply	2.3 V ~ 2.7 V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
	Report errors?

APA600-FGG676 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

APA600-FGG676 Payment Methods

APA600-FGG676 Shipping Methods

If you have any question about APA600-FGG676, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com